

DSF20545SF FAST RECOVERY DIODE

APPLICATIONS

- Induction Heating.
- A.C. Motor Drives.
- Inverters And Choppers.
- Welding.
- High Frequency Rectification.
- UPS.

FEATURES

- Double Side Cooling.
- High Surge Capability.
- Low Recovery Charge.

VOLTAGE RATINGS

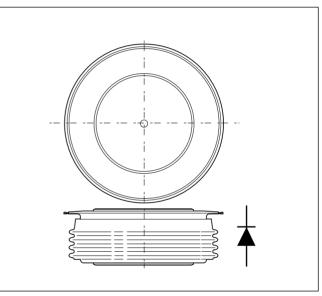
| Type Number | Repetitive Peak Reverse Voltage V _{RRM} V | Conditions |
|--------------|---|----------------------------|
| DSF20545SF45 | 4500 | $V_{RSM} = V_{RRM} + 100V$ |
| DSF20545SF44 | 4400 | |
| DSF20545SF43 | 4300 | |
| DSF20545SF42 | 4200 | |
| DSF20545SF41 | 4100 | |
| DSF20545SF40 | 4000 | |

Lower voltage grades available.

CURRENT RATINGS

| Symbol | Parameter | Conditions | Max. | Units | | | |
|---------------------|-------------------------------------|--|------|-------|--|--|--|
| Double Side Cooled | | | | | | | |
| I _{F(AV)} | Mean forward current | Half wave resistive load, $T_{case} = 65^{\circ}C$ | 1256 | А | | | |
| I _{F(RMS)} | RMS value | $T_{case} = 65^{\circ}C$ | 1971 | A | | | |
| I _F | Continuous (direct) forward current | $T_{case} = 65^{\circ}C$ | 1765 | A | | | |
| Single Side | e Cooled (Anode side) | | · | | | | |
| I _{F(AV)} | Mean forward current | Half wave resistive load, $T_{case} = 65^{\circ}C$ | 995 | А | | | |
| I _{F(RMS)} | RMS value | $T_{case} = 65^{\circ}C$ | 1552 | A | | | |
| I _F | Continuous (direct) forward current | $T_{case} = 65^{\circ}C$ | 1335 | A | | | |

| KEY PARAMETERS | | |
|--------------------|----------------|--|
| V _{RRM} | 4500V | |
| I _{F(AV)} | 1256A | |
| I _{FSM} | 16000A | |
| Q | 1250 μC | |
| t, | 7.0 μs | |



Outline type code: CB450. Turn to page 8 for further information.

SURGE RATINGS

| Symbol | Parameter | Conditions | Max. | Units |
|------------------|--|--|-------------------------|------------------|
| I _{FSM} | Surge (non-repetitive) forward current | 10 ms half since with $0%$ V T = $150%$ | 16 | kA |
| l²t | I ² t for fusing | 10ms half sine; with 0% V_{RRM} , $T_j = 150^{\circ}C$ | 1280 x 10 ³ | A ² s |
| I _{FSM} | Surge (non-repetitive) forward current | $10mc$ holf since with 50% $V_{\rm c}$ T = 150% | 12.8 | kA |
| l²t | I ² t for fusing | 10ms half sine; with 50% V_{RRM} , $T_j = 150^{\circ}C$ | 819.2 X 10 ³ | A ² s |
| I _{FSM} | Surge (non-repetitive) forward current | 10mc half since with $100%$ V T = $150%$ | - | kA |
| l²t | I ² t for fusing | 10ms half sine; with 100% V_{RRM} , $T_j = 150^{\circ}C$ | - | A²s |

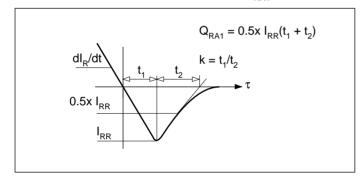
THERMAL AND MECHANICAL DATA

| Symbol | Parameter | Conditions | | Min. | Max. | Units |
|-------------------------|---------------------------------------|---|-------------|------|-------|-------|
| R _{th(j-c)} | Thermal resistance - junction to case | Double side cooled | dc | - | 0.022 | °C/W |
| | | Single side cooled | Anode dc | - | 0.032 | °C/W |
| | | | Cathode dc | - | 0.032 | °C/W |
| R _{th(c-h)} TI | Thermal resistance - case to heatsink | Clamping force 15kN with mounting compound | Double side | - | 0.004 | °C/W |
| | | | Single side | - | 0.008 | °C/W |
| T _{vj} | Virtual junction temperature | On-state (conducting) | | - | 150 | °C |
| T _{stg} | Storage temperature range | | | -55 | 150 | °C |
| - | Clamping force | | | 17.5 | 21.5 | kN |

CHARACTERISTICS

| Symbol | Parameter | Conditions | Тур. | Max. | Units |
|------------------|------------------------------|---|------|------|-------|
| V _{FM} | Forward voltage | At 1800A peak, $T_{case} = 25^{\circ}C$ | - | 2.1 | V |
| I _{RRM} | Peak reverse current | At V_{RRM} , $T_{\text{case}} = 150^{\circ}\text{C}$ | - | 50 | mA |
| t _{rr} | Reverse recovery time | | - | 7.0 | μs |
| Q _{RA1} | Recovered charge (50% chord) | I _F = 1000A, di _{RR} /dt = 100A/μs | - | 1250 | μC |
| I _{RM} | Reverse recovery current | $T_{case} = 150^{\circ}C, V_{R} = 100V$ | - | 400 | A |
| к | Soft factor | | 1.8 | - | - |
| V _{TO} | Threshold voltage | At $T_{vj} = 150^{\circ}C$ | - | 1.36 | V |
| r _T | Slope resistance | At $T_{vj} = 150^{\circ}C$ | - | 0.47 | mΩ |
| V _{FRM} | Forward recovery voltage | di/dt = 1000A/µs, T _j = 125°C | - | 160 | V |

DEFINITION OF K FACTOR AND $\mathbf{Q}_{_{\mathrm{RA1}}}$



CURVES

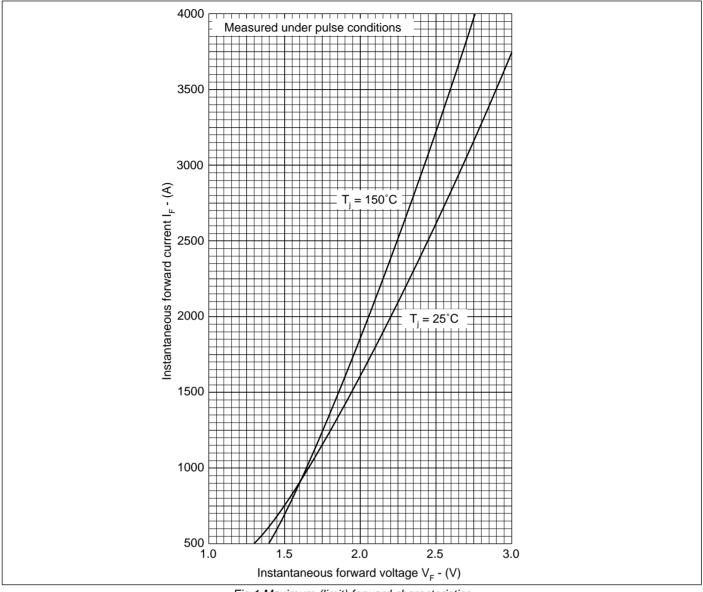


Fig.1 Maximum (limit) forward characteristics

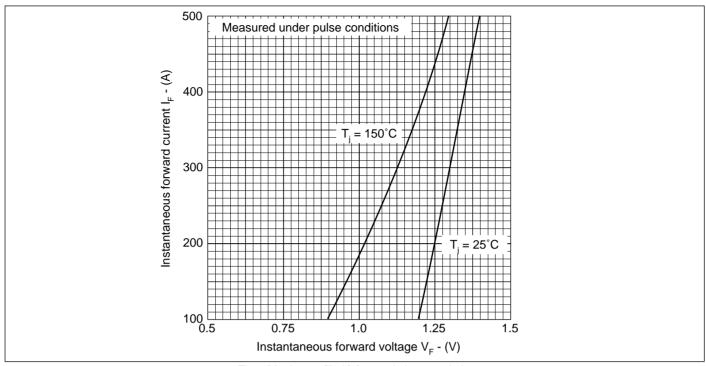


Fig.2 Maximum (limit) forward characteristics

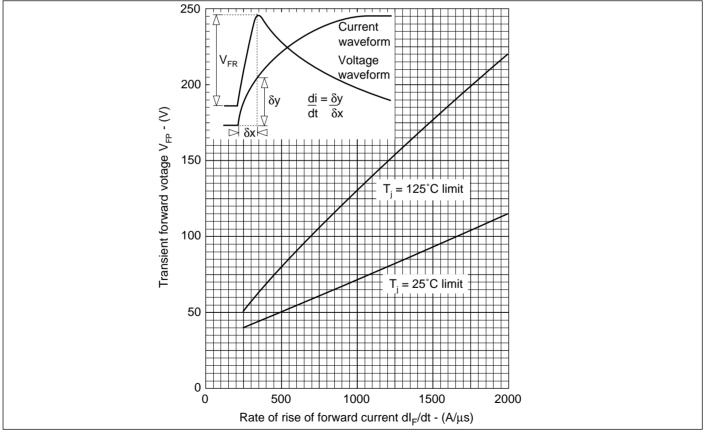
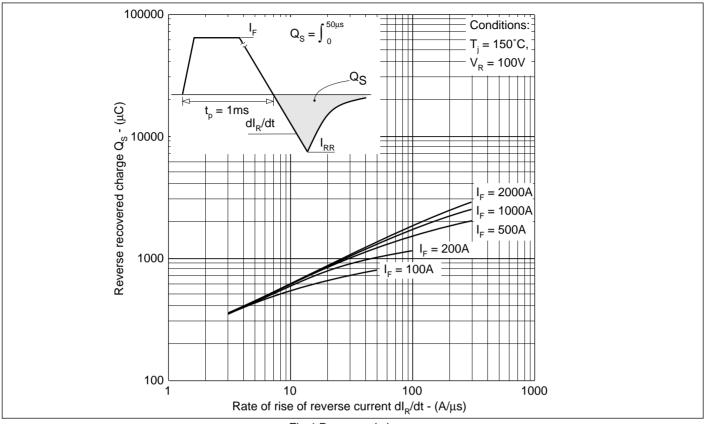
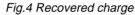
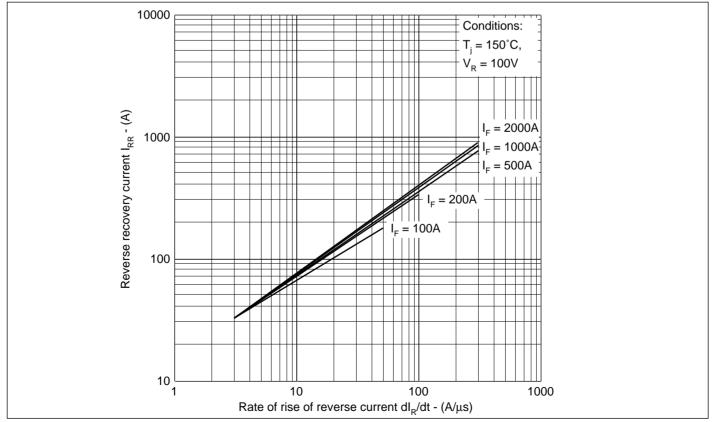


Fig.3 Transient forward voltage vs rate of rise of forward current









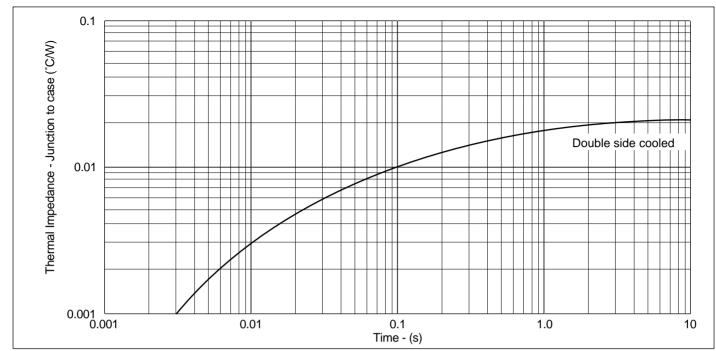
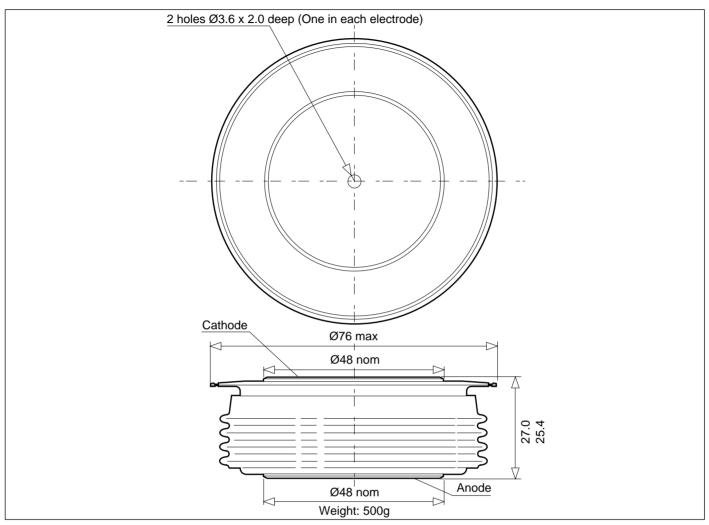


Fig.6 Maximum (limit) transient thermal impedance - junction to case - (°C/W)

PACKAGE DETAILS - CB450

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



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